

## ABSTRACT OF THE DISCLOSURE

A surface-mountable glass-sealed light-emitting diode is  
5 provided. It has high reliability and high external quantum  
efficiency, and can achieve a low-cost components-implemented  
board. An LED bare chip (1) has opposite surfaces, which are  
provided with electrodes (2) for supplying power from  
external. A pair of dumet wires (3) are separately connected  
10 to the respective electrodes (2) sandwiching the LED bare chip  
(1) therebetween. The LED bare chip (1), the electrodes (2)  
and parts of the dumet wires (3) are integrally glass-sealed  
(4). A pair of metallic disc plates (6) have holes (5) formed  
through the center. They are secured on both sides of the  
15 glass seal (4) and solder-plated, allowing the pair of dumet  
wires (3) projected from the glass seal to pass through the  
holes (5).